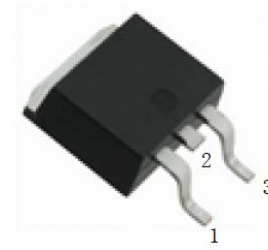


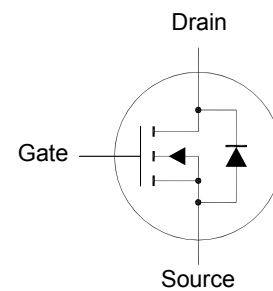
SFTN60R

N-Channel Enhancement Mode MOSFET



1.Gate 2.Drain 3.Source

TO-252 Plastic Package



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current	I_D	$T_C = 25^\circ\text{C}$ 1.9 $T_C = 100^\circ\text{C}$ 1.2	A
Peak Drain Current	I_{DM}	7.6	A
Power Dissipation	P_D	$T_C = 25^\circ\text{C}$ 42	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

Thermal Characteristics

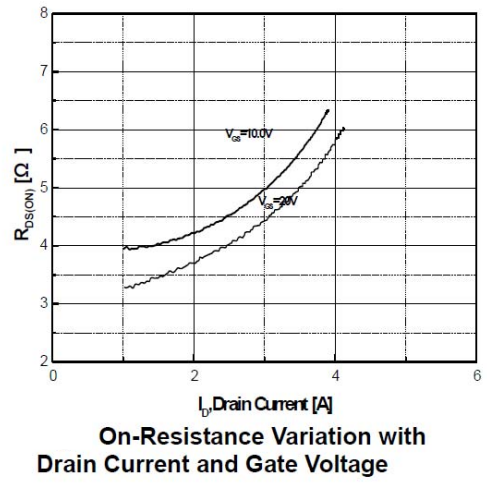
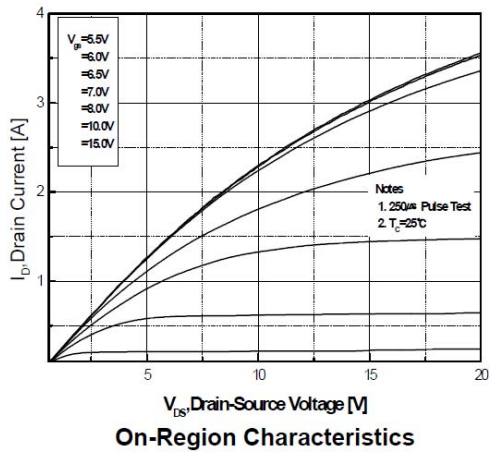
Parameter	Symbol	Max.	Unit
Maximum Thermal Resistance from Junction to Case	$R_{\theta JC}$	2.98	$^\circ\text{C/W}$
Maximum Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	110	$^\circ\text{C/W}$

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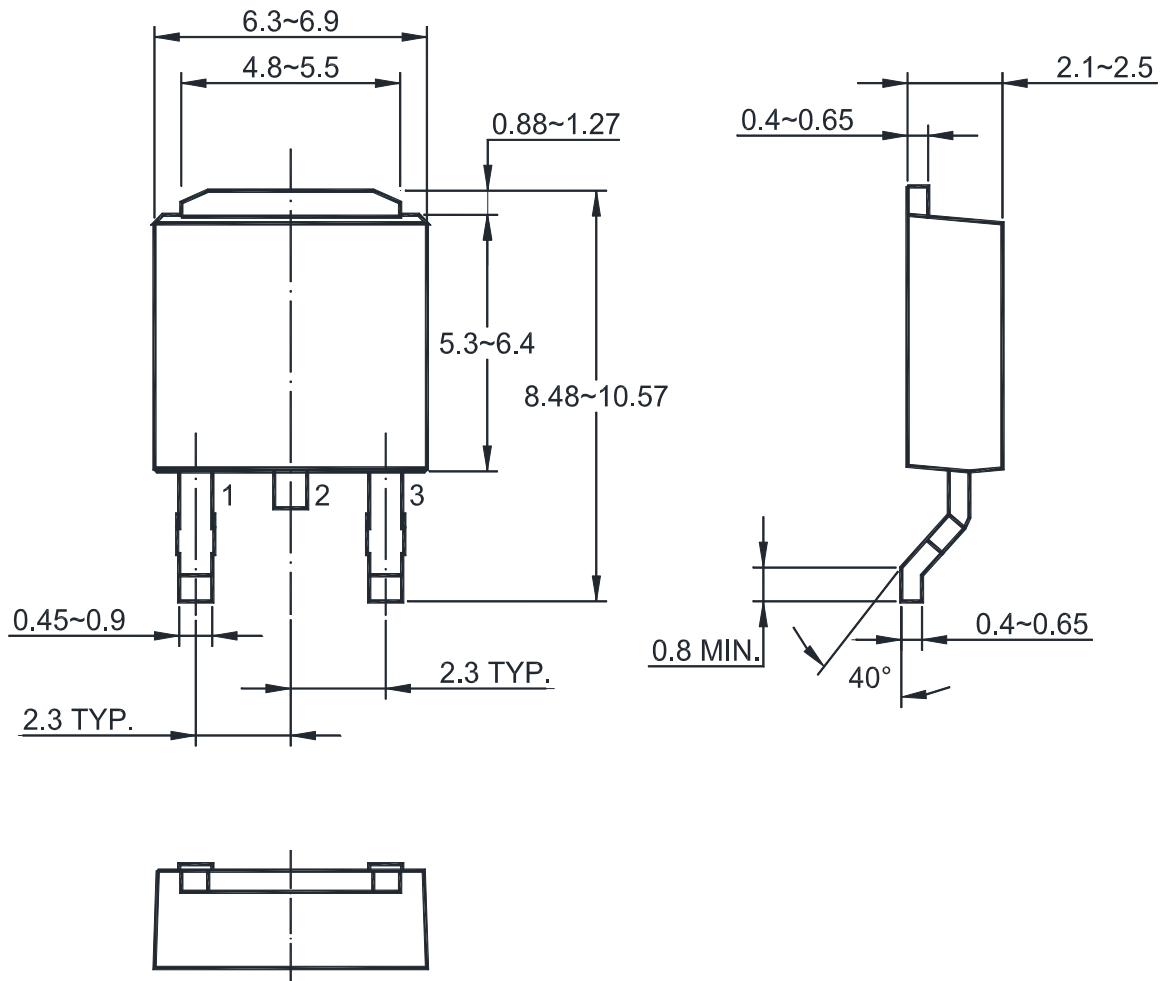
Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 250 \mu\text{A}$	BV_{DSS}	600	-	-	V
Drain-Source Leakage Current at $V_{DS} = 600 \text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 30 \text{ V}$	I_{GSS}	-	-	100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	$V_{GS(th)}$	3	-	5	V
Drain-Source On-State Resistance at $V_{GS} = 10 \text{ V}$, $I_D = 0.95 \text{ A}$	$R_{DS(on)}$	-	-	4.5	Ω
Forward Transconductance at $V_{DS} = 30 \text{ V}$, $I_D = 1 \text{ A}$	g_{FS}	-	0.5	-	S
Diode Forward Voltage at $I_S = 1.9 \text{ A}$, $V_{GS} = 0 \text{ V}$	V_{SD}	-	-	1.4	V
Maximun Body-Diode Continuous Current	I_S	-	4.6	-	A
Input Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	-	360	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	-	2	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	-	40	pF
Turn-On Delay Time at $I_D = 2 \text{ A}$, $V_{GS} = 10 \text{ V}$, $V_{DS} = 300 \text{ V}$, $R_G = 25 \Omega$	$t_{d(on)}$	-	10.6	-	ns
Turn-On Rise Time at $I_D = 2 \text{ A}$, $V_{GS} = 10 \text{ V}$, $V_{DS} = 300 \text{ V}$, $R_G = 25 \Omega$	t_r	-	29.6	-	ns
Turn-Off Delay Time at $I_D = 2 \text{ A}$, $V_{GS} = 10 \text{ V}$, $V_{DS} = 300 \text{ V}$, $R_G = 25 \Omega$	$t_{d(off)}$	-	40.4	-	ns
Turn-Off Fall Time at $I_D = 2 \text{ A}$, $V_{GS} = 10 \text{ V}$, $V_{DS} = 300 \text{ V}$, $R_G = 25 \Omega$	t_f	-	38.4	-	ns

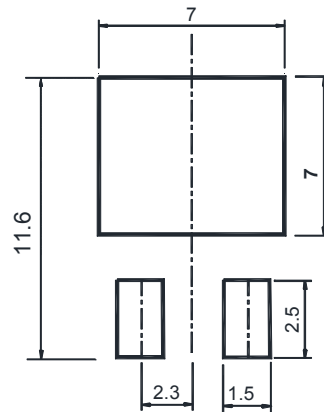


SFTN60R

TO-252 PACKAGE OUTLINE



Recommended Soldering Footprint



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